

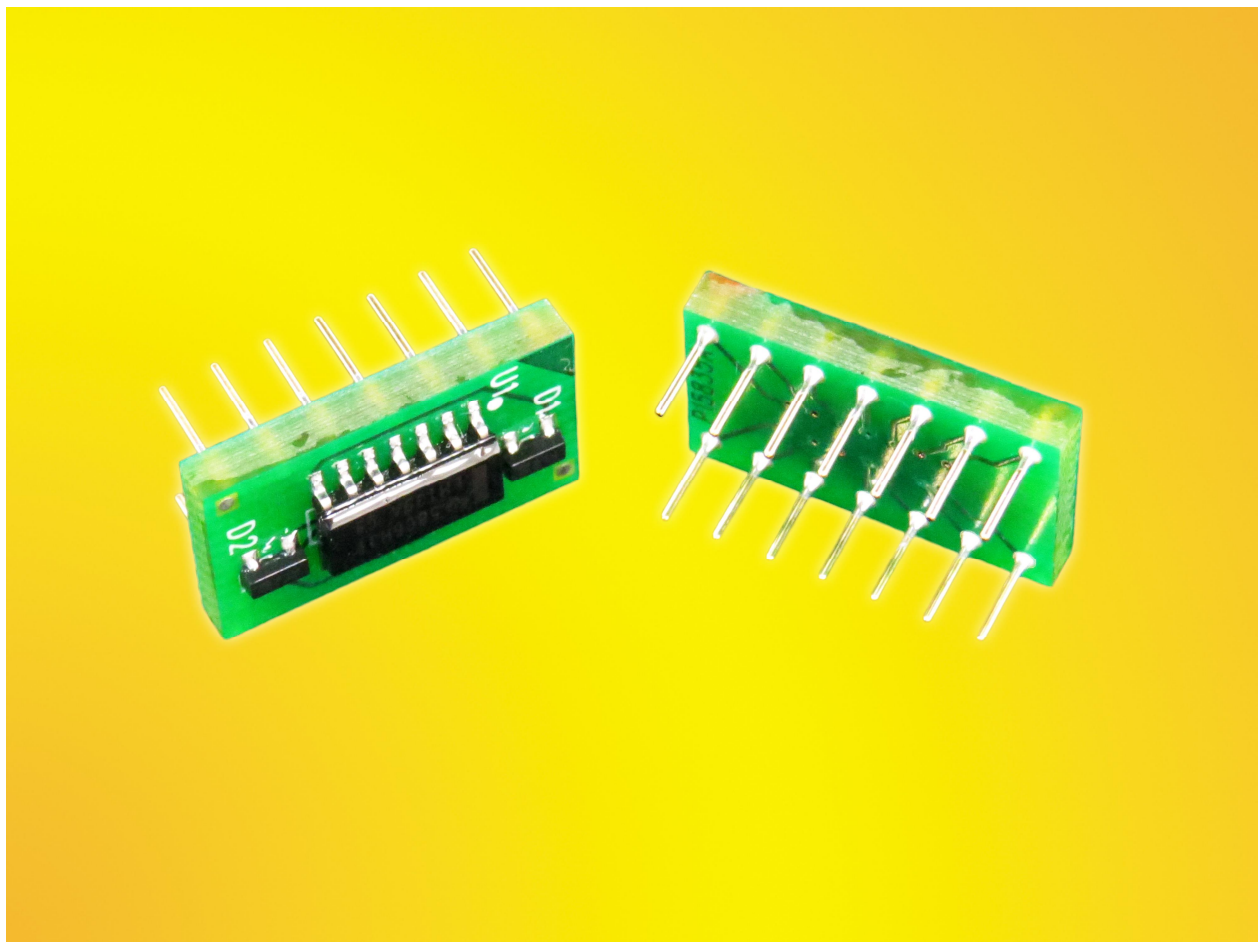


Ironwood
ELECTRONICS

Package Converter Technology allows use of SMT devices on through hole PCB

SOIC package can be installed in boards made for DIP devices, saving the cost and time of re-spinning the PCB

EAGAN, MN - April, 2016 - Ironwood Electronics' new adapter for the 14 pin DIP device allow use of the equivalent IC in SOIC package to be used in PCB boards developed for DIP packages. The PC-SOIC/DIP14-06 is mapped specifically for the Texas Instruments Linear Comparator LM139A. These adapters use an Ironwood exclusive technology that allow high reliability and cost effective package converters from SMT devices to DIP connection. The SOIC package is soldered directly to the top of the adapter and the assembly can then be plugged or soldered to the user's target board. Package convertor consists of gold plated pins for reliable interconnection and substrate that is made of standard FR4 material.



(April, 2016)

B.C.E. S.r.l. - Via Regina Pacis, 54/c - I 41049 Sassuolo (MO), Italy

Tel: (+39) 0536 811616

Fax: (+39) 0536 811500

E-mail: bce@bce.it

Web: www.bce.it